



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
100V	8.8mΩ @ V _{GS} = 10V	47A
	12.9mΩ @ V _{GS} = 4.5V	39A

Description and Applications

This new generation N-channel enhancement mode MOSFET is designed to minimize RDS(ON) yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switch.

- Backlighting
- Power-management functions
- DC-DC converters

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

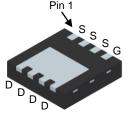
Mechanical Data

- Package: V-DFN3333-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Below Diagram
- Terminals: Finish –NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🚱
- Weight: 0.03 grams (Approximate)

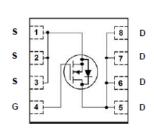
V-DFN3333-8 (Type B)



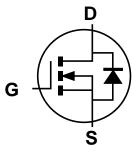




Bottom View



Top View Internal Schematic



Equivalent Circuit

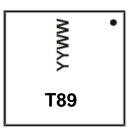
Ordering Information (Note 4)

Part Number	Package	Packing		
Part Number	Fackage	Qty.	Carrier	
DMT10H009LCG-7	V-DFN3333-8 (Type B)	2,000	Tape & Reel	
DMT10H009LCG-13	V-DFN3333-8 (Type B)	3,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



T89 = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 23 = 2023) WW = Week (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	100	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	Steady State	T _A = +25°C T _A = +70°C	l _D	12.4 9.9	А
Continuous Drain Current, V _{GS} = 10V	Steady State	T _C = +25°C T _C = +70°C	lo	47 37	А
Maximum Continuous Body Diode Forward Curre		Is	22	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle =	Ірм	160	Α		
Pulsed Body Diode Continuous Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	160	Α
Avalanche Current, L = 0.3mH (Note 8)			las	21	А
Avalanche Energy, L = 0.3mH (Note 8)			E _{AS}	66	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	129	°C/W
Total Power Dissipation (Note 6)	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta JA}$	59	°C/W
Thermal Resistance, Junction to Case	Rejc	4.2	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

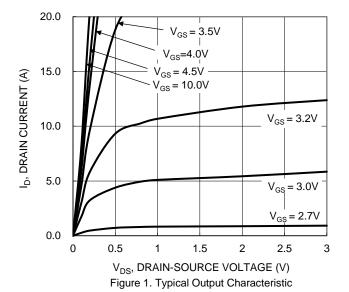
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	Ipss	_	_	1	μA	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	Vgs = ±20V, Vps = 0V	
ON CHARACTERISTICS (Note 7)			ı	ı	ı	, , , , , , , , , , , , , , , , , , , ,	
Gate Threshold Voltage	Vgs(TH)	1.1	_	2.5	V	V _{DS} = V _{GS} , I _D = 250μA	
Static Drain-Source On-Resistance	D	_	7.2	8.8	mΩ	V _{GS} = 10V, I _D = 20A	
Static Drain-Source On-Resistance	RDS(ON)	_	9.8	12.9	mΩ	$V_{GS} = 4.5V, I_{D} = 5A$	
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2309	_		V _{DS} = 50V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	536	_	pF		
Reverse Transfer Capacitance	Crss	_	13.7	_			
Gate Resistance	RG	_	1.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	20.2	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	40.2	_	nC	$V_{DD} = 50V$, $I_D = 20A$,	
Gate-Source Charge	Qgs	_	7.0	_	IIC		
Gate-Drain Charge	Qgd	_	8.5	_			
Turn-On Delay Time	t _{D(ON)}	_	5.4	_			
Turn-On Rise Time	t _R	_	10.6	_		$V_{DD} = 50V$, $V_{GS} = 10V$, $I_{D} = 20A$, $R_{G} = 3\Omega$	
Turn-Off Delay Time	tD(OFF)	_	28.3	_	ns		
Turn-Off Fall Time	tF	_	14.9	_			
Reverse Recovery Time	trr	_	44.3	_	ns	1- 204 4:/44 4004/:	
Reverse Recovery Charge	Q _{RR}	_	65.5	_	nC	$I_F = 20A$, di/dt = 100A/ μ s	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





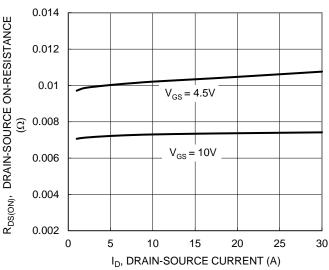


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

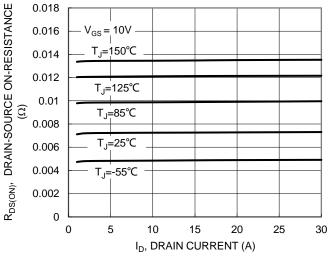


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

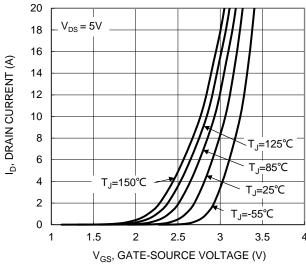


Figure 2. Typical Transfer Characteristic

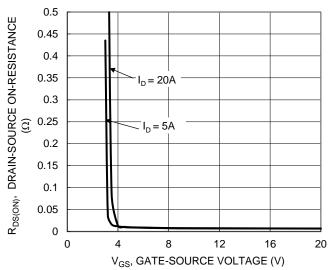


Figure 4. Typical Transfer Characteristic

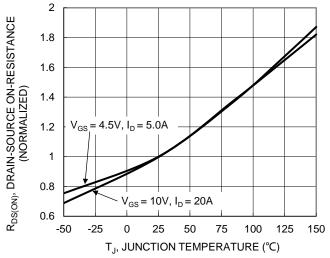


Figure 6. On-Resistance Variation with Junction Temperature



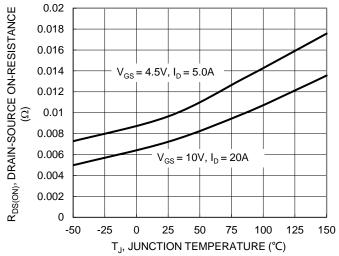


Figure 7. On-Resistance Variation with Junction Temperature

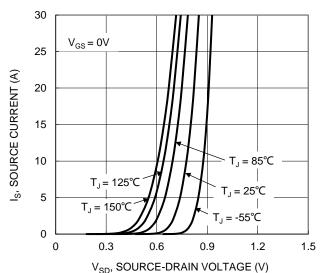


Figure 9. Diode Forward Voltage vs. Current

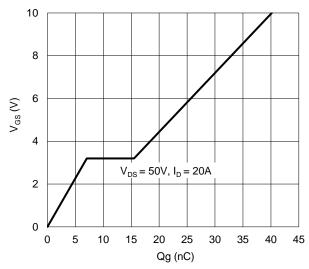


Figure 11. Gate Charge

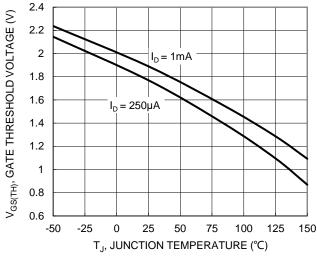
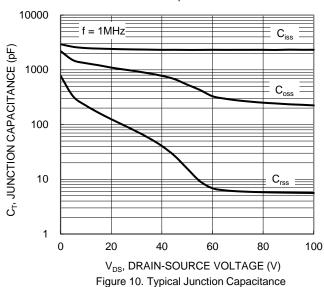


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $R_{DS(ON)}$ LIMITED P_w=100µs 100 ID, DRAIN CURRENT (A) 10 w=1mś T_{J(MAX)}=150°C T_C=25°C P_w=10ms Single Pulse DUT on infinite heatsink V_{GS}=10V 0.1 100 0.1 1 10 1000

V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



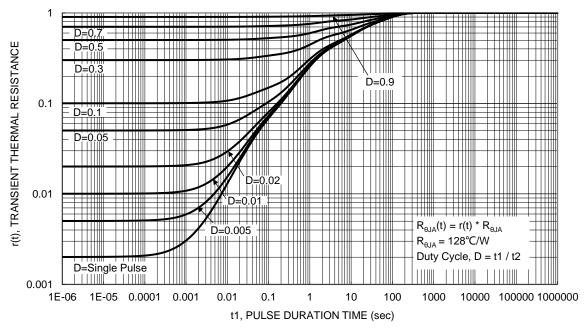
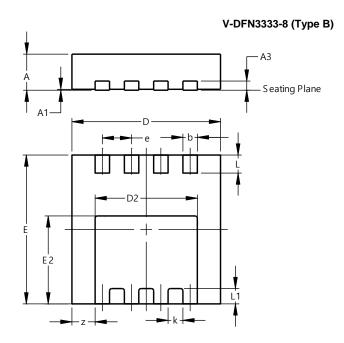


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

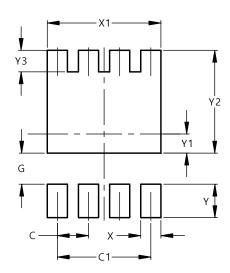


V-DFN3333-8					
(Type B)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	-		0.203		
þ	0.27	0.37	0.32		
D	3.25	3.35	3.30		
D2	2.17	2.37	2.27		
Е	3.25	3.35	3.30		
E2	1.85	2.05	1.95		
е			0.65		
k			0.33		
L	0.35	0.45	0.40		
L1			0.34		
Z			0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN3333-8 (Type B)



Dimensions	Value (in mm)		
C	0.650		
C1	1.950		
G	0.650		
X	0.420		
X1	2.370		
Υ	0.700		
Y1	0.400		
Y2	2.150		
Y3	0.450		



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